



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	BV _{DSS}	Rds(on) Max	I _{D MAX} @T _A = +25°C
Q1	20V	0.45Ω @ V_{GS} = $4.5V$	0.75A
QI	200	0.6Ω @ $V_{GS} = 2.5V$	0.65A
00	0.75Ω @ V _{GS}		-0.6A
Q2	-20V	1.05Ω @ V _{GS} = -2.5V	-0.5A

Description

This new generation MOSFET is designed to minimize on-state resistance (R_{DS(on)}), yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- Battery-Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.
- Power Supply Converter Circuits

Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Complementary Pair MOSFET Ultra-Small Surface Mount Package
- **ESD-Protected**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMC2710UDWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

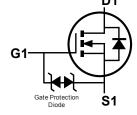
https://www.diodes.com/quality/product-definitions/

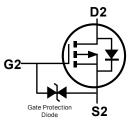
Mechanical Data

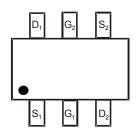
- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Lead-Frame (Lead-Free Plating). Solderable per MIL-STD-202, Method 208@3
- Terminal Connections: See Diagram
- Weight: 0.006 grams (Approximate)











Top View

Q1 N-Channel

Q2 P-Channel

Top View Pin-Out

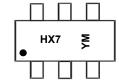
Ordering Information (Note 4)

Part Number	Case	Packaging
DMC2710UDWQ-7	SOT363	3000/Tape & Reel
DMC2710UDWQ-13	SOT363	10000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



HX7 = Product Type Marking Code YM or YM= Date Code Marking Y or \overline{Y} = Year (ex: I = 2021) M = Month (ex: 9 = September)

Date Code Key

Year	2019		2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	G			J	K	L	М	N	0	Р	R	S
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteris	Symbol	Q1 Value	Q2 Value	Unit		
Drain-Source Voltage	V _{DSS}	20	-20	V		
Gate-Source Voltage			V_{GSS}	±6	±6	V
Continuous Drain Current (Note 6) N-Channel: V_{GS} = 4.5V P-Channel: V_{GS} = -4.5V	Steady State	T _A = +25°C T _A = +70°C	I _D	0.75 0.6	-0.6 -0.47	А
Maximum Continuous Body Diode Forward C	Is	0.5	-0.4	Α		
Pulsed Drain Current (10μs Pulse, Duty Cycle	e = 1%)		I _{DM}	5	-2.5	Α

Thermal Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	P_{D}	0.29	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ heta JA}$	433	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	P _D	0.38	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{ heta JA}$	325	°C/W
Operating and Storage Temperature Range		$T_{J_{i}}T_{STG}$	-55 to +150	°C

Electrical Characteristics N-CHANNEL – Q1 (@ T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)						•		
Drain-Source Breakdown Voltage		BV _{DSS}	20	1	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current @)T _C = +25°C	I _{DSS}	_	-	100	nA	V _{DS} = 20V, V _{GS} = 0V	
Gate-Source Leakage		I _{GSS}	_	_	±1.0	μΑ	$V_{GS} = \pm 4.5 V, V_{DS} = 0 V$	
ON CHARACTERISTICS (Note 7)	ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage		V _{GS(th)}	0.5	_	1.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
				0.18	0.45		$V_{GS} = 4.5V, I_D = 600mA$	
Static Drain-Source On-Resistance		R _{DS(on)}	_	0.21	0.6	Ω	V_{GS} = 2.5V, I_D = 500mA	
				0.26	0.75		V _{GS} = 1.8V, I _D = 350mA	
Diode Forward Voltage (Note 7)		V_{SD}	_	0.7	1.2	V	V _{GS} = 0V, I _S = 150mA	
DYNAMIC CHARACTERISTICS (Note 8)								
Input Capacitance		C _{iss}	_	42	_	pF		
Output Capacitance		Coss	_	13	_	pF	V _{DS} = 16V, V _{GS} = 0V -f = 1.0MHz	
Reverse Transfer Capacitance		Crss	_	6.5	_	pF	1 - 1.000112	
Total Gate Charge		Qg	_	0.6	_	nC		
Gate-Source Charge		Qgs	_	0.1	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$ $I_{D} = 250 \text{mA}$	
Gate-Drain Charge		Q _{gd}	_	0.1	_	nC	- ID - 230IIIA	
Turn-On Delay Time		t _{D(on)}	_	4.9	_	ns		
Turn-On Rise Time		t _R	_	3.1	_	ns	$V_{DD} = 10V, V_{GS} = 4.5V,$	
Turn-Off Delay Time		t _{D(off)}	_	386	_	ns	$R_L = 47\Omega, R_g = 10\Omega$ - $I_D = 200 \text{mA}$	
Turn-Off Fall Time		t _F	_	174	_	ns	7 ID - 20011IA	
Reverse Recovery Time		t _{RR}	_	88	_	ns	1 44 11/14 4004/	
Reverse Recovery Charge		Q_{RR}	_	29	_	nC	I _F = 1A, di/dt = 100A/μs	

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

^{6.} Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
7. Short duration pulse test used to minimize self-heating effect.

^{8.} Guaranteed by design. Not subject to production testing.



Electrical Characteristics P-CHANNEL – Q2 (@ T_A = +25°C, unless otherwise specified.)

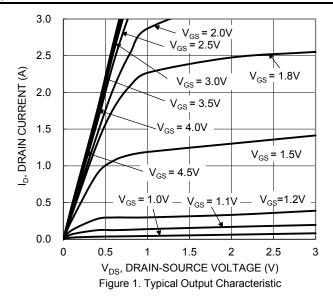
Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)								
Drain-Source Breakdown Voltage		BV _{DSS}	-20	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current @	T _C = +25°C	I _{DSS}	_	_	-100	nA	V _{DS} = -20V, V _{GS} = 0V	
Gate-Source Leakage		I _{GSS}	_	_	±2.0	μΑ	V _{GS} = ±4.5V, V _{DS} = 0V	
ON CHARACTERISTICS (Note 7)	ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage		V _{GS(th)}	-0.5	1	-1.0	>	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
				0.48	0.75		$V_{GS} = -4.5V$, $I_D = -430mA$	
Static Drain-Source On-Resistance		R _{DS(on)}	_	0.6	1.05	Ω	V_{GS} = -2.5V, I_D = -300mA	
				0.76	1.5		V _{GS} = -1.8V, I _D = -150mA	
Diode Forward Voltage (Note 7)		V _{SD}	_	-0.7	-1.2	V	V _{GS} = 0V, I _S = -150mA	
DYNAMIC CHARACTERISTICS (Note 8)								
Input Capacitance	nput Capacitance		_	49	_	pF		
Output Capacitance		Coss	_	12	_	pF	V _{DS} = -16V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance		C _{rss}	_	3.4	_	pF	1 - 1.0Wii 12	
Total Gate Charge		Q_g	_	0.7	_	nC		
Gate-Source Charge		Q _{gs}	_	0.1	_	nC	$V_{GS} = -4.5V, V_{DS} = -10V,$	
Gate-Drain Charge		Q_{gd}	_	0.1	_	nC	I _D = -250mA	
Turn-On Delay Time		t _{D(on)}	_	16	_	ns		
Turn-On Rise Time		t _R	_	15	_	ns	$V_{DS} = -10V, V_{GS} = -4.5V,$	
Turn-Off Delay Time		t _{D(off)}	_	213	_	ns	$R_g = 10\Omega, R_L = 47\Omega$ $I_D = -200 \text{mA}$	
Turn-Off Fall Time		t _F	_	89	_	ns	1020011A	
Reverse Recovery Time		t _{RR}	_	10.5	_	ns	L - 4A di/dt - 400A/	
Reverse Recovery Charge		Q _{RR}	_	1.8	_	nC	I _F = 1A, di/dt = 100A/μs	

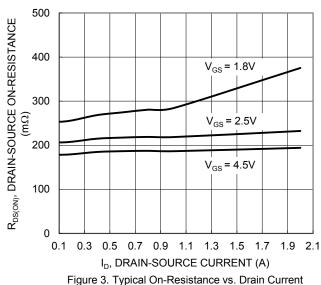
Notes:

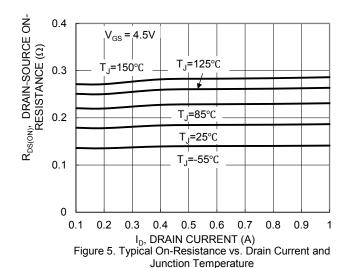
^{7.} Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to production testing.



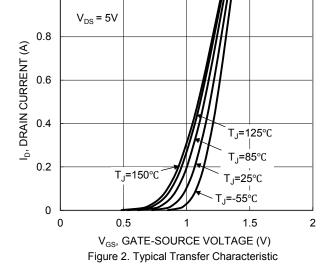
Typical Characteristics - N-CHANNEL







and Gate Voltage



1

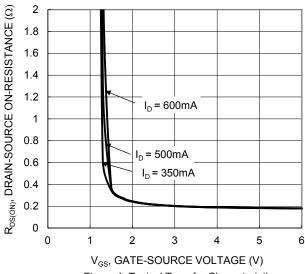


Figure 4. Typical Transfer Characteristic

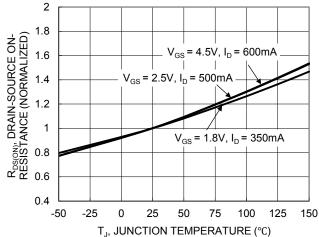


Figure 6. On-Resistance Variation with Junction
Temperature



Typical Characteristics - N-CHANNEL (continued)

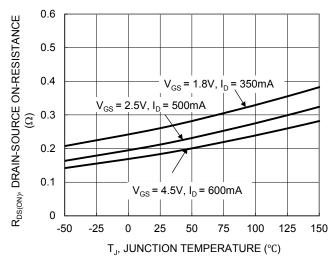
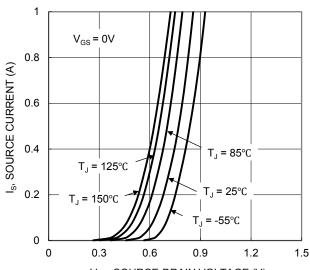


Figure 7. On-Resistance Variation with Junction Temperature



V_{SD}, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current

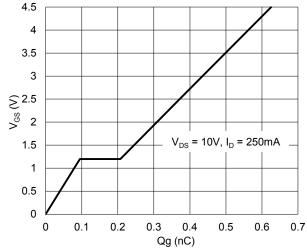


Figure 11. Gate Charge

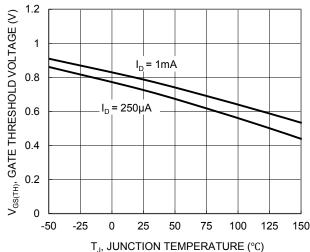


Figure 8. Gate Threshold Variation vs. Junction
Temperature

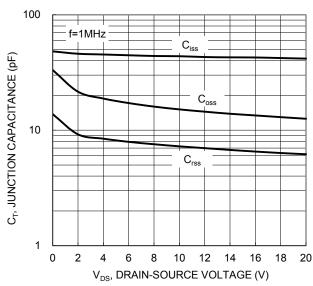


Figure 10. Typical Junction Capacitance

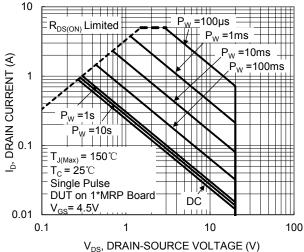
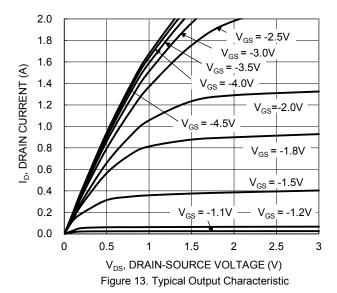
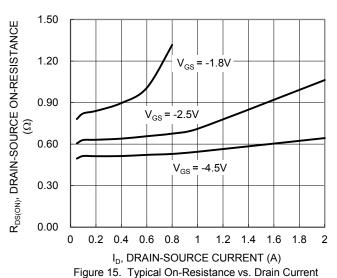


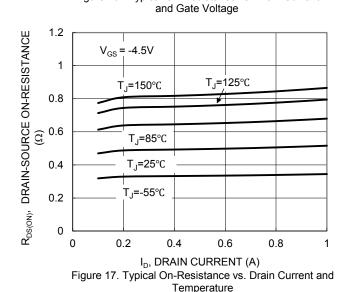
Figure 12. SOA, Safe Operation Area

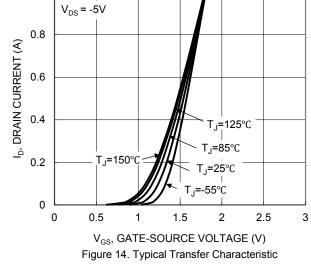


Typical Characteristics - P-CHANNEL









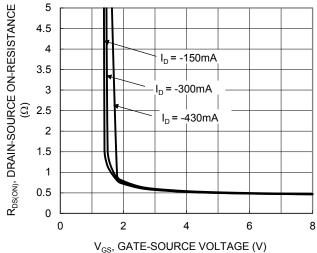


Figure 16. Typical Transfer Characteristic

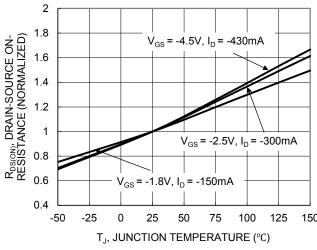


Figure 18. On-Resistance Variation with Temperature



Typical Characteristics - P-CHANNEL (continued)

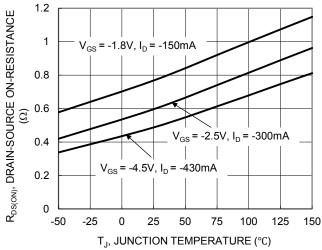


Figure 19. On-Resistance Variation with Temperature

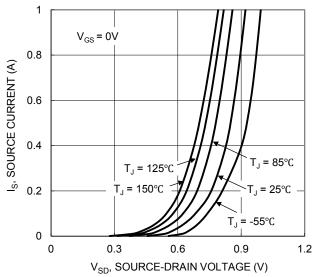


Figure 21. Diode Forward Voltage vs. Current

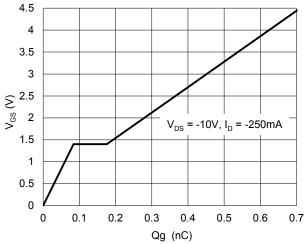


Figure 23. Gate Charge

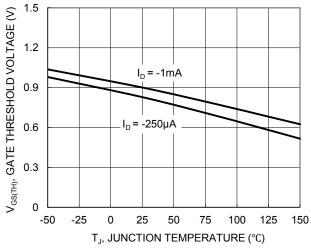
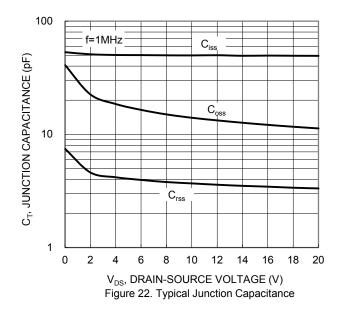


Figure 20. Gate Threshold Variation vs. JunctionTemperature



10 P_{W,}=100µs R_{DS(ON)} Limited $P_W = 1 ms$ ID, DRAIN CURRENT (A) 1 $P_{W} = 100 \text{ms}$ $P_W = 1s$ $T_{J(Max)} = 150 ^{\circ}C$ T_C Single Pulse DC DUT on 1*MRP Board 0.01 0.1 10 100 V_{DS}, DRAIN-SOURCE VOLTAGE (V)

V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 24. SOA, Safe Operation Area



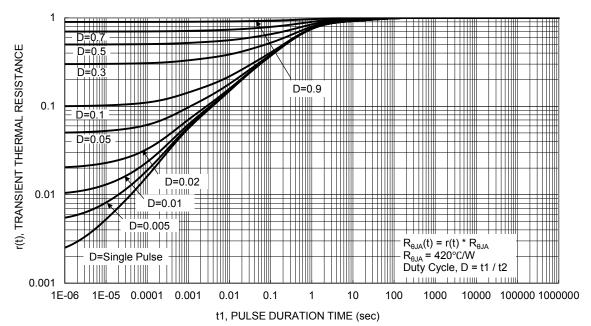
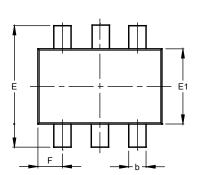


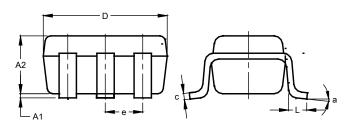
Figure 25. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.





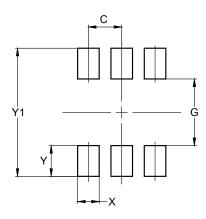
SOT363						
Dim	Min	Max	Тур			
A1	0.00	0.10	0.05			
A2	0.90	1.00	0.95			
b	0.10	0.30	0.25			
С	0.10	0.22	0.11			
D	1.80	2.20	2.15			
Е	2.00	2.20	2.10			
E1	1.15	1.35	1.30			
е	C	0.650 BSC				
F	0.40	0.45	0.425			
L	0.25	0.40	0.30			
а	0°	8°				
All	Dimen	sions	in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363

SOT363



Dimensions	Value			
Dillielisiolis	(in mm)			
С	0.650			
G	1.300			
Х	0.420			
Y	0.600			
Y1	2 500			



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